

## Application Data Sheet

### **Application Information**

Application number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R??::

Number of CD disks::

Number of copies of CDs::

Sequence Submission::

Computer Readable Form (CRF)::

Number of copies of CRF::

Title:: METHOD FOR FABRICATING  
SEMICONDUCTOR DEVICE WITH IMPROVED  
REFRESH TIME

Attorney Docket Number:: 00939H-087500US

Request for Early Publication:: No

Request for Non-Publication:: No

Suggested Drawing Figure::

Total Drawing Sheets:: 6

Small Entity?:: No

Latin name::

Variety denomination name::

Petition included?:: No

Petition Type::

Licensed US Govt. Agency::

Contract or Grant Numbers One::

Secrecy Order in Parent Appl.: No

### **Applicant Information**

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: South Korea  
Status:: Full Capacity  
Given Name:: Jae-Geun  
Middle Name::  
Family Name:: OH  
Name Suffix::  
City of Residence:: Kyoungki-do  
State or Province of Residence::  
Country of Residence:: South Korea  
Street of Mailing Address:: San 136-1, Ami-ri, Bubal-eub, Ichon-shi  
City of Mailing Address:: Kyoungki-do  
State or Province of mailing address::  
Country of mailing address:: South Korea  
Postal or Zip Code of mailing address:: 467-860

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: South Korea  
Status:: Full Capacity  
Given Name:: Byung-Seop  
Middle Name::  
Family Name:: HONG  
Name Suffix::  
City of Residence:: Kyoungki-do  
State or Province of Residence::  
Country of Residence:: South Korea  
Street of Mailing Address:: San 136-1, Ami-ri, Bubal-eub, Ichon-shi  
City of Mailing Address:: Kyoungki-do

State or Province of mailing address::

Country of mailing address:: South Korea

Postal or Zip Code of mailing address:: 467-860

### **Correspondence Information**

Correspondence Customer Number:: 20350

### **Representative Information**

Representative Customer Number:: 20350

### **Domestic Priority Information**

Application:: Continuity Type:: Parent Application:: Parent Filing Date::

### **Foreign Priority Information**

Country::	Application number::	Filing Date::
Korea, South	2003-43081	06/30/03

### **Assignee Information**

Assignee Name:: Hynix Semiconductor Inc.

Street of mailing address:: San 1367-1, Ami-ri, Bubal-eub

City of mailing address:: Ichon-shi

State or Province of mailing address:: Kyoungki-do

Country of mailing address:: Republic of Korea

Postal or Zip Code of mailing address:: 467-860